

HSF

NOTES:

Current Rating: 3.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 1000V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40℃ to +105℃

Contact Material: Phosphor Bronze
Contact plating: Au Or Sn over Ni
Insulator Material: PA9T+30%G.F UL94V-0

Ordering Information

2150 - 2 XX W XX CUN X 1

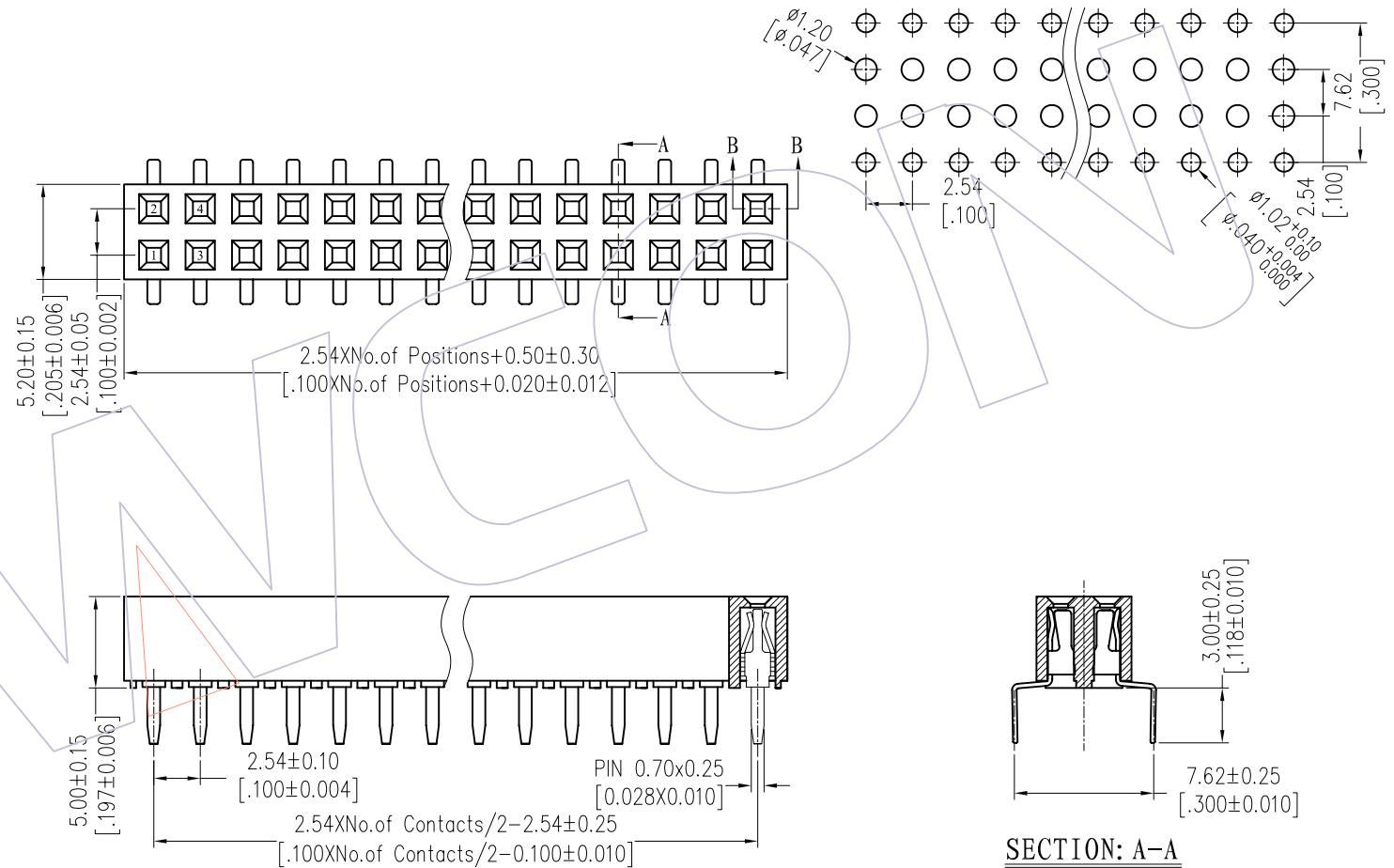
No. of Pins per
ROW: 02~40PIN

Contact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"Gold
S0=Gold Flash/Tin
S3=10μ"Gold/Tin
S4=15μ"Gold/Tin
S5=30μ"Gold/Tin
SN=Tin
SM=Matte Tin

Packing:
T=Tube

Item	Pitch	Mating
Standard	2.54	1115/1120/1125
Alternate		

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



SECTION: B-B

SECTION: A-A

				OPERATION		DRAW JYHuang	DATE 2012/08/06	SCALE UNIT mm	FIT mm	PART NO. 2150-2XXWXXCUNX1	
				X.X	±0.40					TITLE: FH2.54 DUAL ROW Centipede (7.62) H=5.0	
				X.XX	±0.25	CHECK	DATE	SIZE A4	SHEET 1/1	Customer NO.	
				X.XXX	±0.15						
				Angle	± 3°	APPROVE	DATE	PROJ.	Customer NO.		
REV	DATE	MODIFICATION DESCRIPTION		DIM	TOL						